

NCE8205B

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE8205B uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

• $V_{DS} = 20V, I_D = 6.5A$

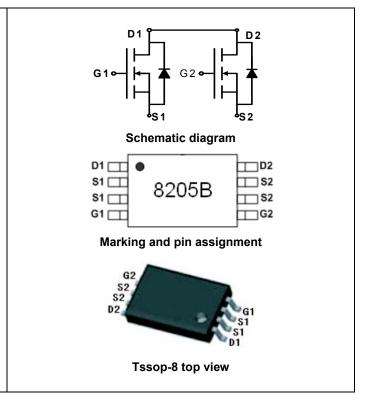
 $R_{DS(ON)}$ < 27m Ω @ V_{GS} =2.5V

 $R_{DS(ON)}$ < 22m Ω @ V_{GS} =4.5V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- Battery protection
- Load switch
- Power management



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
8205B	NCE8205B	TSSOP-8	Ø330mm	12mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	20	V	
Gate-Source Voltage	V _{GS}	±12	V	
Drain Current-Continuous	I _D	6.5	Α	
Drain Current-Pulsed (Note 1)	I _{DM}	25	Α	
Maximum Power Dissipation	P _D	1.5	W	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	83	°C/W

Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0 V I_D =250 μ A	20	-	ı	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =20V, V_{GS} =0V	-	-	1	μΑ



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Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	0.5	0.7	1.2	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =4.5A	-	15	22	mΩ
Drain-Source On-State Resistance		V _{GS} =2.5V, I _D =3.5A	-	19	27	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =4.5A	-	10	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V _{DS} =10V,V _{GS} =0V,	-	900	-	PF
Output Capacitance	Coss	V _{DS} =10V,V _{GS} =0V, F=1.0MHz	-	220	-	PF
Reverse Transfer Capacitance	C _{rss}	F = 1.01VII 12	-	100	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	10	20	nS
Turn-on Rise Time	t _r	V _{DD} =10V,I _D =1A	-	11	25	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =4.5 V , R_{GEN} =6 Ω	-	35	70	nS
Turn-Off Fall Time	t _f		-	30	60	nS
Total Gate Charge	Q_g	\/ -10\/ -64	-	12	15	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=10V,I_{D}=6A,$ $V_{GS}=4.5V$	-	2.3	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} -4.5V	-	1	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =1.7A	-	0.75	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	6.5	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

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Typical Electrical and Thermal Characteristics

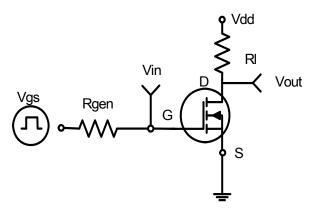
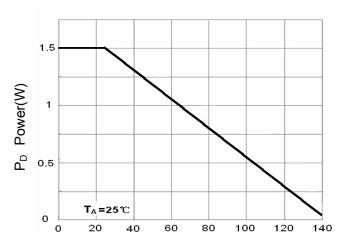


Figure 1:Switching Test Circuit



 T_J -Junction Temperature($^{\circ}$ C)

Figure 3 Power Dissipation

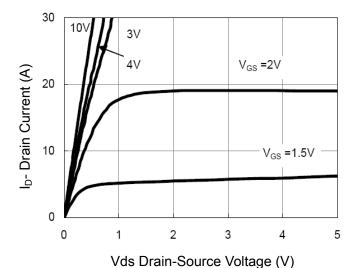


Figure 5 Output Characteristics

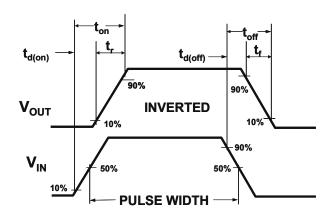


Figure 2:Switching Waveforms

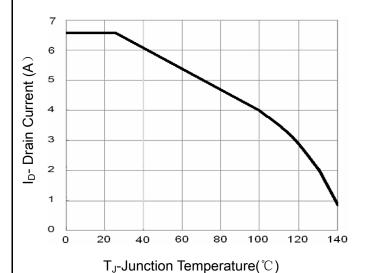


Figure 4 Drain Current

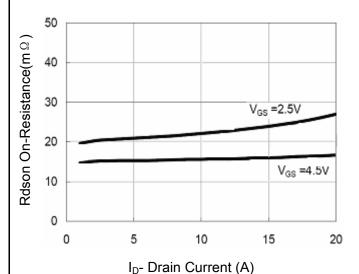
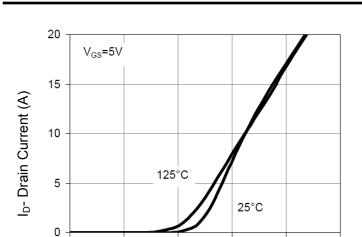


Figure 6 Drain-Source On-Resistance



0.0

0.5



Vgs Gate-Source Voltage (V)

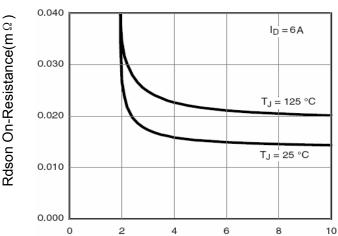
1.0

Figure 7 Transfer Characteristics

1.5

2.0

2.5



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

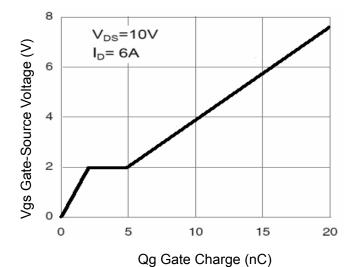
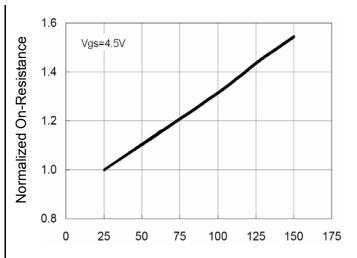
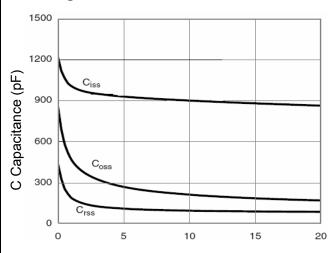


Figure 11 Gate Charge



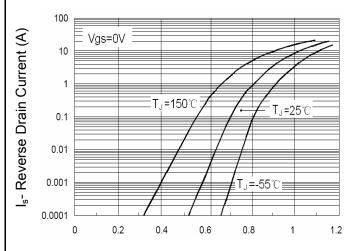
 $\mathsf{T}_{\mathsf{J}} ext{-}\mathsf{Junction}\ \mathsf{Temperature}({}^{\circ}\!\mathsf{C})$

Figure 8 Drain-Source On-Resistance



Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V)

Figure 12 Source- Drain Diode Forward

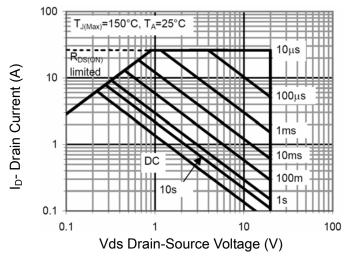


Figure 13 Safe Operation Area

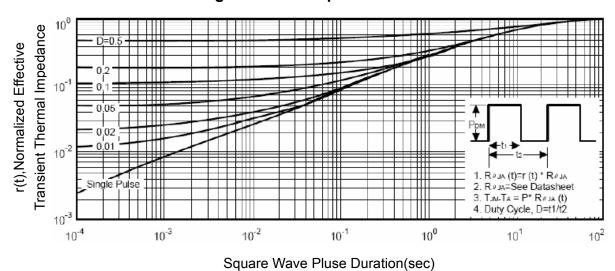
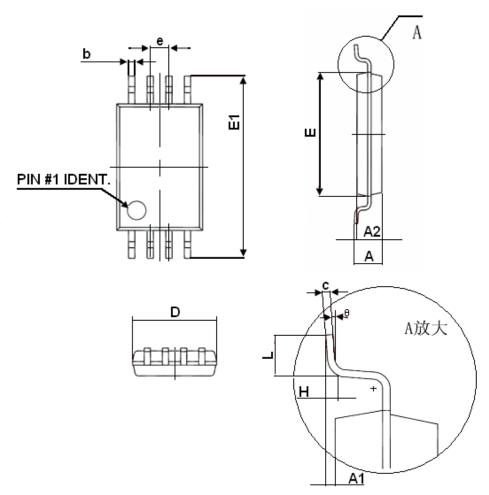


Figure 14 Normalized Maximum Transient Thermal Impedance



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Tssop-8 Package Information



Symbol	Dimensions In Millimeters			
	Min	Max		
D	2.900	3.100		
E	4.300	4.500		
b	0.190	0.300		
С	0.090	0.200		
E1	6.250	6.550		
Α		1.100		
A2	0.800	1.000		
A1	0.020	0.150		
е	0.65(BSC)			
L	0.500 0.700			
Н	0.25(TYP)			
Θ	1° 7°			



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